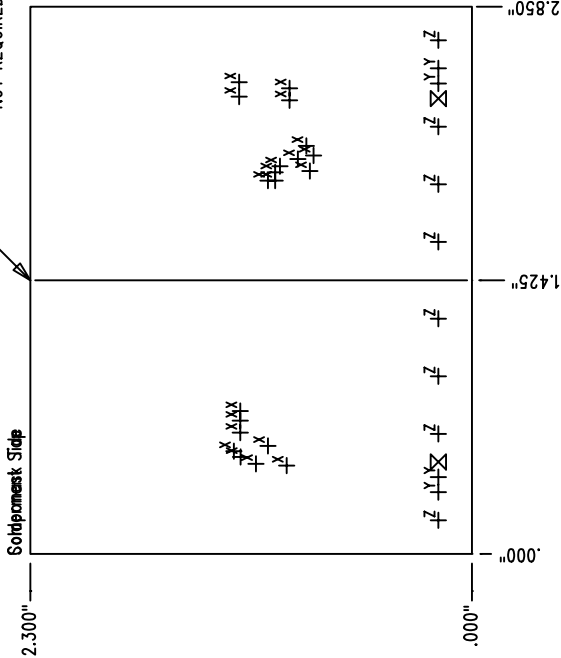


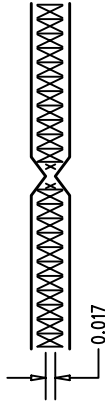
REVISIONS		
REV	DESCRIPTION	DATE

SCORED : FOR FINAL PRODUCTION FABRICATION ONLY
NOT REQUIRED FOR PROTOTYPE BOARD




NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/--.006 TOTAL OF 4 LAYERS
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC)
3. SOLDER MASK : BOTH SIDES USING LPI
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
5. ALL DIMENSIONS ARE IN INCHES
6. SCORING:



SIZE	QTY	SYM	PLTD
40	2	X	PLTD
15	20	X	PLTD
35	4	Y	PLTD
64	8	Z	PLTD

Fabrication Drawing

APPROVALS					1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
	INIT	DATE	LT3467ES6			
DRAWN			1.2MHz, SOT-23 DC/DC Converter			
CHECK			SIZE A			
DESIGN			Demo Circuit			
ENGR			DC647A			
			REV.			
SCALE = NONE					SHT 1 of 1	